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About this book. Edited by key figures in 3D integration and written by top authors from high-tech companies and renowned research institutions, this book covers the intricate details of 3D process technology. As such, the main focus is on silicon via formation, bonding and debonding, thinning, via reveal and backside processing, both from a technological and a materials science perspective.

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Handbook of 3D Integration, Volumes 1 and 2: Technology and Applications of 3D Integrated Circuits. 1st Edition. by Philip Garrou (Editor), Christopher Bower (Editor), Peter Ramm (Editor) & 0 more. ISBN-13: 978-3527332656. ISBN-10: 9783527332656.

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An essential part of successfully introducing a new technology is to educate engineers and managers on its benefits and tradeoffs. That's why Wiley started publishing the Handbook of 3D Integration Series with Volume 1 and 2 in 2008, followed by Volume 3 in 2014. This blog covers Volume 4, introduced in early May 2019.

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